#### **Description**

TUNN ARIS

The ASMD0603 series provides miniature surface mount resettable overcurrent protection with holding current from 100mA to 500mA.

This world's smallest PTC is suitable for ultra portable applications where space is at a premium and the device current is low.

#### **Features**

- RoHS compliant and lead-free
- Low profile
- Halogen-free
- Fast response to fault current
- Compact design saves board space
- MWW.Malli Compatible with high temperature solders

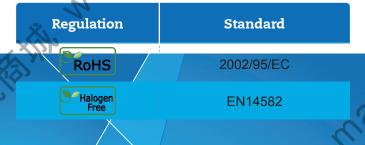
# **Agency Approvals**

Mallinnicc

#### Agency File Number c **FL** us pending pending

#### **Applications**

- Mobile phones and PDAs
- USB peripherals
- Portable MP3 and media player
- IC VCC protection
- Mobile Internet Device (MID)



#### **Performance Specification**

Model	V max	Imax	I hold	I trip	Pa	Maxi Time T		Resistance	
Model	(V dc)	(A)	@25°C (A)	@25°C (A)	Typ. (W)	Current (A)	Time (Sec)	Rimin (Ω)	R1max (Ω)
ASMD0603-010	15.0	40	0.10	0.30	0.5	0.5	1.00	0.900	6.000
ASMD0603-020	9.0	40	0.20	0.50	0.5	1.0	0.60	0.550	3.500
ASMD0603-025	9.0	40	0.25	0.55	0.5	8.0	0.08	0.500	3.000
ASMD0603-035	6.0	40	0.35	0.75	0.5	8.0	0.10	0.200	1.400
ASMD0603-050	6.0	40	0.50	1.00	0.5	8.0	0.10	0.100	0.800
ASMD0603-075	6.0	40	0.75	1.40	0.5	8.0	0.10	0.060	0.450
ASMD0603-100	6.0	40	1.00	2.00	0.5	8.0	0.10	0.040	0.300

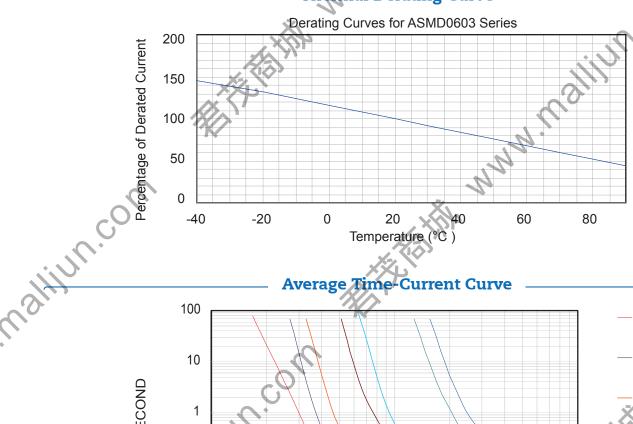
Hold Current. Maximum current device will not trip in 25°C still air.

I hold = Hold Current. Maximum current device    hrip = Trip Current. Minimum current at which   v max = Maximum operating voltage device car   I max = Maximum fault current device can with	the device will always trip in 25°C still withstand without damage at rated cu	irrent (Imax).
P <sub>d</sub> = Power dissipation when device is in the		nent at rated voltage.
R <sub>i min/max</sub> = Minimum/Maximum device resistance		
R <sub>1max</sub> = Maximum device resistance is measure CAUTION: Operation beyond the specified rat	•	e arcing and flame
CAOTION . Operation beyond the specimed rat	ings may result in damage and possible	e arcing and hame.
Envir	onmental Specifications —	
Test	Conditions	Resistance change
Passive aging	+85°C, 1000 hrs.	±5% typical
Humidity aging	+85°C, 85% R.H., 168 hours	±5% typical
Thermal shock	+85°C to -40°C, 20 times	±33% typical
Resistance to solvent	MIL-STD-202,Method 215	No change
Vibration / Vibration	MIL-STD-202, Method 201	No change

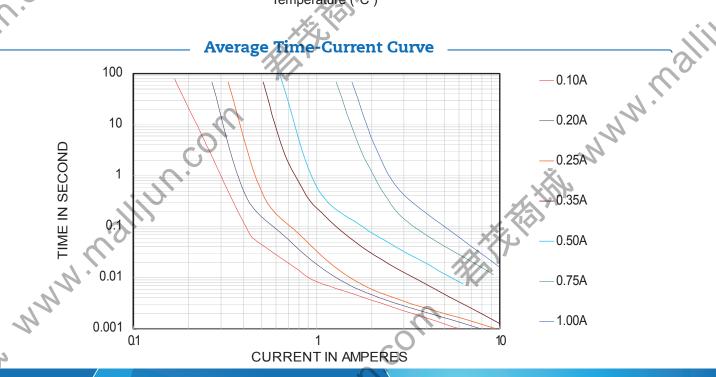
Ambient operating conditions : - 40 °C to +85 °C

Maximum surface temperature of the device in the tripped state is 125 °C

#### **Thermal Derating Curve**



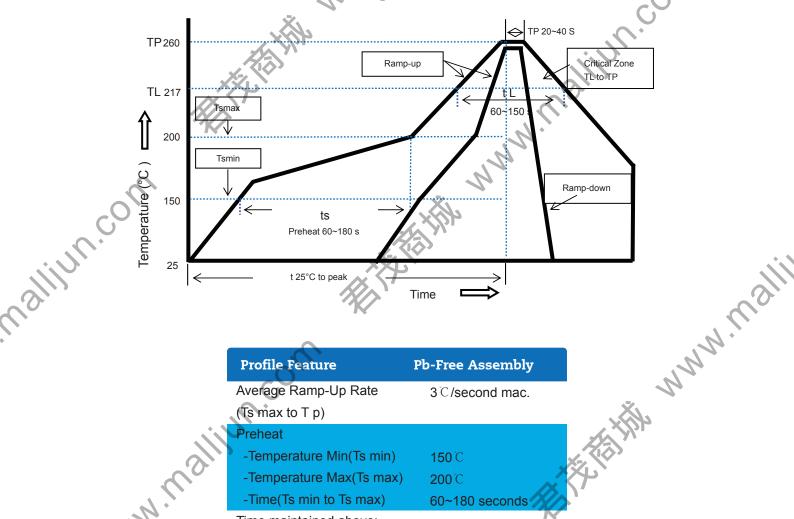
### **Average Time-Current Curve**



#### Thermal Derading Chart

Model	Maximum ambient operating temperature (Tmao) vs. hold current (Ihold)								
Model	- 40°C	- 20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C
ASMD0603-010	0.13	0.12	0.11	0.10	0.08	0.07	0.06	0.05	0.03
ASMD0603-020	0.27	0.25	0.23	0.20	0.17	0.14	0.12	0.10	0.07
ASMD0603-025	0.32	0.29	0.27	0.25	0.21	0.18	0.16	0.05	0.03
ASMD0603-035	0.47	0.41	0.38	0.35	0.29	0.26	0.24	0.20	0.14
ASMD0603-050	0.67	0.59	0.54	0.50	0.41	0.37	0.34	0.29	0.20
ASMD0603-075	0.98	0.85	0.81	0.75	0.60	0.54	0.44	0.40	0.31
ASMD0603-100	1.30	1.12	1.08	1.00	0.80	0.72	0.58	0.53	0.42

# **Soldering Parameters**



Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate	3℃/second mac.
(Ts max to T p)	
Preheat	
-Temperature Min(Ts min)	150℃
-Temperature Max(Ts max)	200℃
-Time(Ts min to Ts max)	60~180 seconds
Time maintained above:	K
-Temperature(TL)	<b>217</b> °C
-Time(tL)	60~150 seconds
Peak Temperature(Tp)	260
Ramp-Down Rate	6C/second max.
Time 25°C to Peak Temperation	ure 8 minutes max
Storage Condition	0 C~35 C,≤70%RH

Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free

Recommended maximum paste thickness is 0.25mm

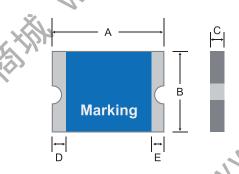
WWW.Malli

Devices can be cleaned using standard industry methods and solvents.

Note 1:All temperature refer to topside of the package, measured on the package body surface.

Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

### Physical Dimensions(mm.)



	1	Physical	Dimensi	ons(mn	n.)		-0 <sup>(1</sup>	
		Ma  →  D	rking		NNIC	Allle		
				1				
Wodel		A	В	XI.	•	C	D	E
Model	Min.	A Max.	Min.	Max.	Min.	Max.	D Min.	E Min.
Model ASMD0603-010				403				
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.
ASMD0603-010	Min. 1.45	Max. 1.85	Min. 0.65	Max. 1.05	Min. 0.40	<b>Max.</b> 1.00	Min. 0.15	Min. 0.10
ASMD0603-010 ASMD0603-020	Min. 1.45 1.45	Max. 1.85 1.85	Min. 0.65	Max. 1.05 1.05	Min. 0.40 0.40	Max. 1.00 1.00	Min. 0.15 0.15	Min. 0.10 0.10
ASMD0603-010 ASMD0603-020 ASMD0603-025	Min. 1.45 1.45 1.45	Max. 1.85 1.85 1.85	Min. 0.65 0.65	Max. 1.05 1.05 1.05	Min. 0.40 0.40 0.40	Max. 1.00 1.00 1.00	Min. 0.15 0.15 0.15	Min. 0.10 0.10 0.10
ASMD0603-010 ASMD0603-020 ASMD0603-025 ASMD0603-035	Min. 1.45 1.45 1.45 1.45	Max. 1.85 1.85 1.85 1.85	Min. 0.65 0.65 0.65 0.65	Max. 1.05 1.05 1.05 1.05	Min. 0.40 0.40 0.40 0.40	Max. 1.00 1.00 1.00 1.00	Min. 0.15 0.15 0.15 0.15	Min. 0.10 0.10 0.10 0.10

**Termination Pad Characteristics** 

Terminal pad materials: Tin-plated Nickel-Copper

Terminal pad solder ability: Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3

#### Packaging Quantity and Marking

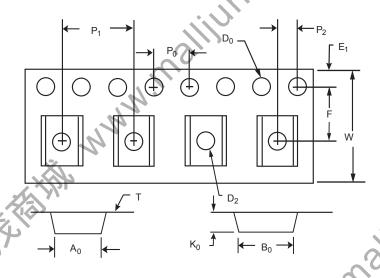


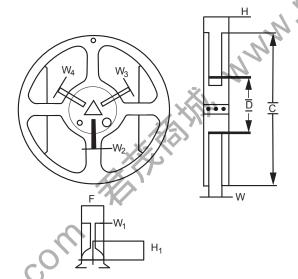
# Tape And Reel Specifications (mm)

	7///2
Governing Specifications	ZA W
W	8.0 ± 0.2
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.05
A0	1.05 ± 0.10
В0	1.85 ± 0.10
B1max.	1.55 + 0.05
D0	$3.5 \pm 0.05$
Ê	1.75 ± 0.10
E1	6.25
E2min.	0.75
Т	0.1
T1max.	0.75/0.95 ± 0.1
K0	
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	
W2	$9.0 \pm 0.5$
12	$12.0 \pm 0.05$

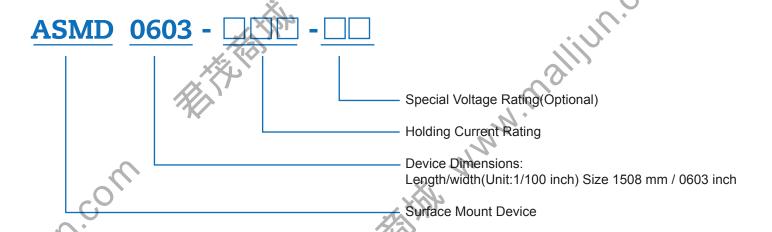
#### Storage And Handling

- Storage conditions: 40°C max, 70% R.H.
- Devices may not meet specified performance
  - if storage conditions are exceeded Technology Corp.





# Part Number System



#### **Cross Reference**

Model	Cross Reference						
Model	Tyco / PolySwitch®	Littelfuse / POLY-FUSE®	Polytronics / EVERFUSE®				
ASMD0603-010	· -	0603L010	SMD0603P010TF				
ASMD0603-020	7,	0603L020	SMD0603P020TF				
ASMD0603-025	-	0603L025	SMD0603P025TF				
ASMD0603-035	-	0603L035	SMD0603P035TF				
ASMD0603-050	-	0603L050	SMD0603P050TF				
ASMD0603-075	-	- %	-				
ASMD0603-100	-	- 0	-				

<sup>&</sup>quot;PolySwitch" is a registered trademark of Tyco Electronics.

<sup>&</sup>quot;POLY-FUSE" is a registered trademark of Littelfuse, Inc.

<sup>&</sup>quot;EVERFUSE" is a registered trademark of Polytronics Technology Corp.